AMPMODU | AMPMODU Headers

TE Internal #: 87221-5

PCB Mount Header, Vertical, Board-to-Board, 6 Position, 3.81 mm [. 15 in] Centerline, Unshrouded, Gold, Through Hole - Solder, Signal,

AMPMODU Headers

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Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical
Connector System: Board-to-Board

Number of Positions: 6
Number of Rows: 1

Features

Product Type Features

| PCB Connector Assembly Type | PCB Mount Header |
|-----------------------------------|-----------------------|
| Connector System | Board-to-Board |
| Header Type | Unshrouded |
| Sealable | No |
| Connector & Contact Terminates To | Printed Circuit Board |

Configuration Features

| Connector Contact Load Condition | Fully Loaded |
|----------------------------------|--------------|
| PCB Mount Orientation | Vertical |
| Number of Positions | 6 |
| Number of Rows | 1 |
| Board-to-Board Configuration | Parallel |

Electrical Characteristics

| Insulation Resistance | 5000 ΜΩ |
|---------------------------------------|----------|
| Dielectric Withstanding Voltage (Max) | 750 Vrms |

Body Features

| Primary Product Color | Black | |
|-----------------------|-------|--|
|-----------------------|-------|--|

Contact Features

| | Mating Square Post Dimension | .64 mm[.025 in] |
|--|------------------------------|-----------------|
|--|------------------------------|-----------------|



| | 50 μin |
|--|----------------------------|
| Contact Shape & Form | Square |
| Contact Underplating Material | Nickel |
| PCB Contact Termination Area Plating Material | Gold Flash |
| Contact Base Material | Phosphor Bronze |
| Contact Mating Area Plating Material | Gold |
| Contact Mating Area Plating Material Thickness | .76 μm[30 μin] |
| Contact Type | Pin |
| Contact Current Rating (Max) | 5 A |
| ermination Features | |
| Square Termination Post & Tail Dimension | .64 mm[.025 in] |
| Termination Post & Tail Length | 3.18 mm[.125 in] |
| Termination Method to PCB | Through Hole - Solder |
| lechanical Attachment | |
| Mating Alignment | Without |
| PCB Mount Retention | Without |
| PCB Mount Alignment | Without |
| Connector Mounting Type | Board Mount |
| ousing Features | |
| Centerline (Pitch) | 3.81 mm[.15 in] |
| Housing Material | Thermoplastic |
| imensions | |
| PCB Thickness (Recommended) | 1.57 mm[.062 in] |
| sage Conditions | |
| Operating Temperature Range | -65 – 105 °C[-85 – 221 °F] |
| peration/Application | |
| Circuit Application | Signal |
| dustry Standards | |
| UL Flammability Rating | UL 94V-0 |
| ackaging Features | |
| Packaging Quantity | 400 |
| | 100 |



Product Compliance

For compliance documentation, visit the product page on TE.com>

| EU RoHS Directive 2011/65/EU | Compliant |
|---|---|
| EU ELV Directive 2000/53/EC | Compliant |
| China RoHS 2 Directive MIIT Order No 32, 2016 | No Restricted Materials Above Threshold |
| EU REACH Regulation (EC) No. 1907/2006 | Current ECHA Candidate List: JUNE 2024 (241) Candidate List Declared Against: JUNE 2024 (241) Does not contain REACH SVHC |
| Halogen Content | BFR/CFR/PVC Free, but Br/Cl >900 ppm in other sources. |
| Solder Process Capability | Wave solder capable to 240°C |

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



Also in the Series | AMPMODU Headers





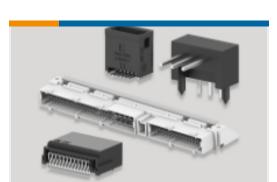
Connector Caps & Covers(1)



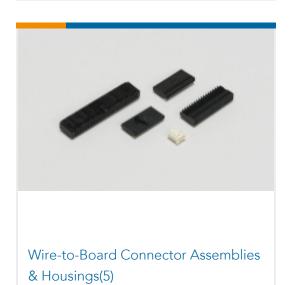
Connector Contacts(64)



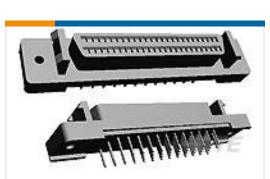
Connector Hardware(2)



PCB Headers & Receptacles(3202)



Customers Also Bought



TE Part #5749721-7 68 50SR VERT RCPT ASSY



TE Part #5-1622820-9 3520 68R 5%



TE Part #2-382811-1 SHUNT, ECON, PHBRSN, BLACK



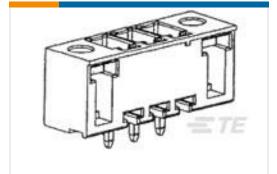
TE Part #6-103639-9
20 MTE HDR SRST LATCH .100CL



TE Part #1-1318301-4
3.96EP HDR ASSY 4(7)P NAT/TUBE



TE Part #284517-3
3P TERMIBLOK HDR DIR POLAR



TE Part #796867-4 4 POS TERMI-BLOK HDR VERTICAL



TE Part #796867-8 8 POS TERMI-BLOK HDR VERTICAL



TE Part #282836-7
TERMI-BLOK PCB MOUNT 90 7P.



TE Part #284517-2 2P TERMIBLOK HDR DIR POLAR

Documents

PCB Mount Header, Vertical, Board-to-Board, 6 Position, 3.81 mm [.15 in] Centerline, Unshrouded, Gold, Through Hole - Solder, Signal, AMPMODU Headers



CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_87221-5_M_c-87221-5-m.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_87221-5_M_c-87221-5-m.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_87221-5_M_c-87221-5-m.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use

Agency Approvals

UL

English